No.: RGC-K-HTS-0001 /13

Date: 2017. 4. 21

# Data sheet

Title: FIXED THICK FILM CHIP RESISTORS; RECTANGULAR TYPE &

**PRECISION** 

Style: RGC1/32,1/20,1/16S,1/16,1/10,1/8

AEC-Q200 qualified (Without RGC1/32)

RoHS COMPLIANCE ITEM
Halogen and Antimony Free

Note: • Stock conditions

Temperature:  $+5^{\circ}\text{C} \sim +35^{\circ}\text{C}$ Relative humidity:  $25\% \sim 75\%$ 

The period of guarantee: Within 2 year from shipmen t by the company.

Solderability shall be satisfied.

• Product specification contained in this data sheet are subject to change at any time without notice.

• If you have any questions or a Purchasing Specification for any quality Agreement is necessary, please contact our sales staff.



Hokkaido Research Center Approval by: T. Sannomiya Drawing by: M. Shibuya KAMAYA OHM

No: RGC-K-HTS-0001

/13

FIXED THICK FILM CHIP RESISTORS; RECTANGULAR TYPE & PRECISION

RGC1/32,1/20,1/16S,1/16,1/10,1/8 Page: 1/13

# 1. Scope

1.1 This data sheet covers the detail requirements for fixed thick film chip resistors; rectangular type & precision, style of RGC1/32,1/20,1/16S,1/16,1/10,1/8.

## 1.2 Applicable documents

JIS C 5201-1: 2011, JIS C 5201-8: 2014, JIS C 5201-8-1: 2014

IEC60115-1: 2008, IEC60115-8: 2009, IEC60115-8-1: 2014

EIAJ RC-2134C-2010

#### 2. Classification

Type designation shall be the following form.

(Example)

RGC	1/8	С	123	D	TP
1	2	3	4	5	6
Sty	le				

1 Fixed thick film chip resistors; rectangular type & precision

Style

2 Rated dissipation and / or dimension

3 Temperature coefficient of resistance

K	±100×10 <sup>6</sup> / °C
С	±50×10 <sup>6</sup> / °C

# 4 Rated resistance

123	E24 Series, 3 digit,	Ex. 123> 12kΩ,
1000	E96 Series, 4 digit,	Ex. 1000>100Ω
		1022> 10.2kΩ

#### 5 Tolerance on rated resistance

В	±0.1%
D	±0.5%
F	±1%

# 6 Packaging form

<u> </u>	
В	Bulk (loose package)
PA	Press pocket taping
TH	Donortoning
TP	Paper taping

FIXED THICK FILM CHIP RESISTORS; RECTANGULAR TYPE & PRECISION

RGC1/32,1/20,1/16S,1/16,1/10,1/8 Page: 2/13

## 3. Rating

3.1 The ratings shall be in accordance with Table-1.

#### Table-1

Style	Rated		e coefficient of	Rated resistance	Preferred number	Tolerance on rated
Style	dissipation (W)	resistance	e ( 10⁴ / °C)	$range(\Omega)$	series for resistors	resistance
RGC1/32	0.03	С	± 50	100~100k	E24,96	D(±0.5%)
DCC1/20	0.05	С	± 50	1k~1M	E34.06	B(±0.1%),
RGC1/20	0.05	K	±100	51~976	E24,96	D(±0.5%)
		С	± 50	100~1M		B(±0.1%),
RGC1/16S	0.063	K	.400	1.02M~3.3M	E24,96	D(±0.5%)
		r.	±100	10~97.6		F(±1%)
		С	±50	100~1M		B(±0.1%),
DCC1/16	0.1			1.02M~3.3M	E24.06	D(±0.5%)
RGC1/16	0.1	K	±100	10~97.6	E24,96	F(±1%)
				3.3~9.76		D(±0.5%)F(±1%)
						B(±0.1%),
RGC1/10	0.125	С	± 50	10~3.3M	E24,96	D(±0.5%)
KGC1/10	0.125	C	± 50		E24,90	F(±1%)
				3.3~9.76		D(±0.5%)F(±1%)
						B(±0.1%),
RGC1/8	0.25	С	± 50	10~4.7M	E24,96	D(±0.5%)
NGC 1/0	0.25	C	± 30		L24,90	F(±1%)
				3.3~9.76		F(±1%)

Style	Limiting element voltage	Isolation voltage	Category temperature
	(V)	(V)	range(°C)
RGC1/32	15	50	-55~+125
RGC1/20	25	30	
RGC1/16S	EQ.		
RGC1/16	50	100	<i>–</i> 55∼+155
RGC1/10	150	100	
RGC1/8	200		

# 3.2 Climatic category

3.2.1 RGC1/32

55/125/56 Lower category temperature -55 °C

> +125 °C Upper category temperature

> Duration of the damp heat, steady state test 56days

3.2.2 RGC1/20,1/16S,1/16,1/10,1/8

55/155/56 -55 °C Lower category temperature

> +155 °C Upper category temperature Duration of the damp heat, steady state test 56days

3.3 Stability class

5% Limits for change of resistance:

> - for long - term tests  $\pm (5\% + 0.1\Omega)$ - for short - term tests  $\pm (1\% + 0.05\Omega)$

RGC1/32,1/20,1/16S,1/16,1/10,1/8 Page: 3/13

## 3.4 Derating

The derated values of dissipation at temperature in excess of 70 °C shall be as indicated by the following curve.

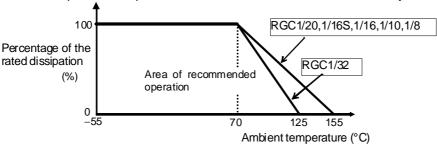


Figure-1 Derating curve

# 3.5 Rated voltage

d.c.or a.c.r.m.s.voltage calculated from the square root of the product of the rated resistance and the rated dissipation.

$$E = \sqrt{P \cdot R}$$

E: Rated voltage (V)

P: Rated dissipation (W)

R: Rated resistance ( $\Omega$ )

Limiting element voltage can only be applied to resistors when the resistance value is equal to or higher than the critical resistance value.

At high value of resistance, the rated voltage may not be applicable.

# 4. Packaging form

The standard packaging form shall be in accordance with Table-2.

# Table-2

Symbol	Packaging form		Standard packaging quantity / units	Application
В	Bulk (loose package)		1,000 pcs.	RGC1/32,1/20,1/16S,1/16,1/10,1/8
PA	Press pocket taping	8mm width, 2mm pitches	20,000 pcs.	RGC1/32
FA	(paper taping)	ornin widin, zmin piiches	15,000 pcs.	RGC1/20
TH	Paper taping	8mm width, 2mm pitches	10,000 pcs.	RGC1/16S
TP	Paper taping	8mm width, 4mm pitches	5,000 pcs.	RGC1/16, 1/10, 1/8

RGC1/32,1/20,1/16S,1/16,1/10,1/8 Page: 4/13

#### 5. Dimensions

5.1 The resistor shall be of the design and physical dimensions in accordance with Figure-2 and Table-3.

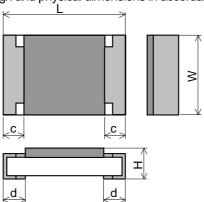


Figure-2

Table–3 Unit: mm

Style	L	W	Н	С	d
RGC1/32	0.4±0.02	0.2±0.02	0.13±0.02	0.08±0.03	0.1±0.03
RGC1/20	0.6±0.03	0.3±0.03	0.23±0.03	0.1±0.05	0.15±0.05
RGC1/16S	1.0±0.05	0.5±0.05	0.35±0.05	0.2±0.1	$0.25^{+0.05}_{-0.10}$
RGC1/16	1.6±0.1	0.8 +0.15 -0.05	0.45±0.10	0.25±0.10	0.3±0.1
RGC1/10	2.0±0.1	1.25±0.10	0.6±0.1	0.4±0.2	0.4±0.2
RGC1/8	3.1±0.1	1.6±0.15	0.6±0.1	0.5±0.25	0.5±0.25

# 5.2 Net weight (Reference)

Style	Net weight(mg)
RGC1/32	0.035
RGC1/20	0.16
RGC1/16S	0.6
RGC1/16	2
RGC1/10	5
RGC1/8	9

# 6. Marking

The Rated resistance shall be marked in 3 digits (E24) or 4 digits (E96) and marked on over coat side.

• E24 series: 3 digits, E96 series: 4 digits

In case of the resistance value that E96 overlaps with E24, It is marked by either.

The Rated resistance of RGC1/16 should not be marked in 4 digits.

The Rated resistance of RGC1/32,1/20,1/16S should not be marked.

Marking example	Contents	Application
123	$12\times10^3 \ [\Omega] \rightarrow 12 \ [k\Omega]$	RGC1/16,1/10,1/8
3R3	3.3 [Ω]	Less than 10Ω of RGC1/16,1/10,1/8
5623	$562\times10^3 [\Omega] \rightarrow 562[k\Omega]$	RGC1/10,1/8
12R7	12.7 [Ω]	RGC1/10,1/8

**KAMAYA OHM** 

No: RGC-K-HTS-0001 /13

FIXED THICK FILM CHIP RESISTORS; RECTANGULAR TYPE & PRECISION

RGC1/32,1/20,1/16S,1/16,1/10,1/8 Page: 5/13

#### 7. Performance

7.1 The standard condition for tests shall be in accordance with Sub-clause 4.2, JIS C 5201–1: 2011.

7.2 The performance shall be satisfied in Table-4.

Table-4(1)

No.	Test items	Condition of test (JIS C 5201–1)	Performance requirements
1	Visual examination	Sub-clause 4.4.1	As in 4.4.1
'	VISUAI EXAITIII IAUOTI	Checked by visual examination.	The marking shall be legible, as
		Checked by visual examination.	checked by visual examination.
2	Dimension	Sub-clause 4.4.2	As specified in Table-3 of this
_		Cub diadoc 4.4.2	specification.
	Resistance	Sub-clause 4.5	As in 4.5.2
			The resistance value shall
			correspond with the rated resistance
			taking into account the specified
			tolerance.
3	Voltage proof	Sub-clause 4.7	No breakdown or flash over
		Method: 4.6.1.4(See Figure–5)	
		Test voltage: Alternating voltage with a peak	
		value of 1.42 times the insulation voltage.	
		Duration: 60 s ± 5 s	D: 400
		Insulation resistance	R≥1GΩ
		Test voltage: Insulation voltage	
4	Coldorability	Duration: 1 min.	As in 4.17.4.5
4	Solderability	Sub-clause 4.17	The terminations shall be covered
		Without ageing Flux: The resistors shall be immersed in a	with a smooth and bright solder
		non–activated soldering flux for 2s.	coating.
		Bath temperature: 235 °C ± 5 °C	oodii ig.
		Immersion time: 2 s ± 0.5 s	
5	Mounting	Sub-clause 4.31	
		Substrate material: Epoxide woven glass	
		Test substrate: Figure–3	
	Overload	Sub-clause 4.13	
	(in the mounted state)	The applied voltage shall be 2.5 times the	
		rated voltage or twice the limiting element	
		voltage, whichever is the less severe.	
		Duration: 2 s	
		Visual examination	
		Resistance	No visible damage
	Solvent resistance of the	Sub-clause 4.30	$\Delta R \le \pm (1\% + 0.05\Omega)$
	marking	Solvent: 2-propanol	Legible marking
	Harking	Solvent temperature: 23 °C ± 5 °C	
		Method 1	
		Rubbing material: cotton wool	
		Without recovery	

FIXED THICK FILM CHIP RESISTORS; RECTANGULAR TYPE & PRECISION

RGC1/32,1/20,1/16S,1/16,1/10,1/8 Page: 6/13

# Table-4(2)

	<b>-</b>		5 (
No	Test items	Condition of test (JIS C 5201–1) Performance requirement	
6	Mounting	Sub-clause 4.31	
		Substrate material: Epoxide woven glass	
		Test substrate: Figure-4	
	Bound strength of the end	Sub-clause 4.33	
	face plating	Bent value: 3 mm	
		Resistance	$\Delta R \le \pm (1\% + 0.05\Omega)$
	Final measurements	Sub-clause 4.33.6	
		Visual examination	No visible damage
7	Resistance to soldering heat	Sub-clause 4.18	
	9	Solder temperature: 260 °C ± 5 °C	
		Immersion time: 10 s ± 0.5 s	
		Visual examination	As in 4.18.3.4
		Viodal Oxali ili ladoli	No sign of damage such as cracks.
		Resistance	$\Delta R \le \pm (1\% + 0.05\Omega)$
	Component solvent	Sub-clause 4.29	Zi( = 2 (17010.0022)
	resistance	Solvent: 2–propanol	
		Solvent temperature: 23 °C ± 5 °C	
		Method 2	
		Recovery: 48 h	
		Visual examination	No visible damage
		Resistance	$\Delta R \le \pm (1\% + 0.05\Omega)$
8	Mounting	Sub-clause 4.31	ZI( = 2 (17010.0002)
U	Modifuing	Substrate material: Epoxide woven glass	
		Test substrate: Figure–3	
	Adhesion	Sub-clause 4.32	
	Adilesion		
		Force: 5 N(RGC1/32: 2N, RGC1/20: 3N)	
		Duration: 10 s ± 1 s	No visible damage
	Rapid change temperature	Visual examination	140 VISIBIC darriage
	rapid change temperature	Sub-clause 4.19	
		RGC1/32	
		Lower category temperature: -55 °C	
		Upper category temperature: +125 °C	
		RGC1/20,1/16S,1/16,1/10,1/8	
		Lower category temperature: -55 °C	
		Upper category temperature: +155 °C	
		Duration of exposure at each temperature: 30	
		min.	
		Number of cycles: 5 cycles.	No visible damage
		Visual examination	_
		Resistance	$\Delta R \le \pm (1\% + 0.05\Omega)$

FIXED THICK FILM CHIP RESISTORS; RECTANGULAR TYPE & PRECISION

RGC1/32,1/20,1/16S,1/16,1/10,1/8 Page: 7/13

# Table-4(3)

No	Test items	Condition of test (JIS C 5201–1)	Performance requirements
9	Climatic sequence	Sub-clause 4.23	
	-Dry heat	Sub-clause 4.23.2	
	,	RGC1/32	
		Test temperature: +125 °C	
		RGC1/20,1/16S,1/16,1/10,1/8:	
		Test temperature: +155 °C	
		Duration: 16 h	
	-Damp heat, cycle	Sub-clause 4.23.3	
	(12+12hour cycle)	Test method: 2	
	First cycle	Test temperature: 55 °C	
	,	[Severity(2)]	
	-Cold	Sub-clause 4.23.4	
		Test temperature –55 °C	
		Duration: 2h	
	-Damp heat, cycle	Sub-clause 4.23.6	
	(12+12hour cycle)	Test method: 2	
	Remaining cycle	Test temperature: 55 °C	
	3 ,	[Severity (2)]	
		Number of cycles: 5 cycles	
	-D.C. load	Sub-clause 4.23.7	
		The applied voltage shall be the rated voltage	
		or the limiting element voltage whichever is the	
		smaller.	
		Duration: 1 min.	Nie Salie de como
		Visual examination	No visible damage
		Resistance	$\Delta R \le \pm (5\% + 0.1\Omega)$
10	Mounting	Sub-clause 4.31	
	_	Substrate material: Epoxide woven glass	
		Test substrate: Figure–3	
	Endurance at 70 °C	Sub-clause 4.25.1	
		Ambient temperature: 70 °C ± 2 °C	
	Duration: 1000 h  The voltage shall be applied in cycles of 1.5 h		
		on and 0.5 h.	
	The applied voltage shall be the rated voltage or the limiting element voltage whichever is the smaller.  Examination at 48 h, 500 h and 1000 h:		
			Nie vielle de se e se
		Visual examination	No visible damage
		Resistance	$\Delta R \le \pm (5\% + 0.1\Omega)$

**KAMAYA OHM** 

No: RGC-K-HTS-0001

/13

FIXED THICK FILM CHIP RESISTORS; RECTANGULAR TYPE & PRECISION

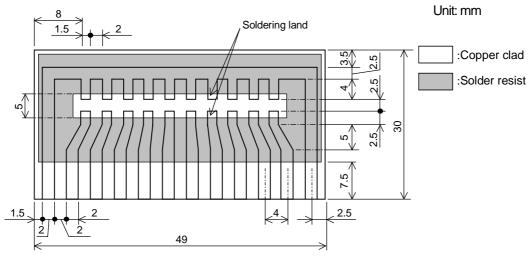
RGC1/32,1/20,1/16S,1/16,1/10,1/8 Page: 8/13

# Table-4(4)

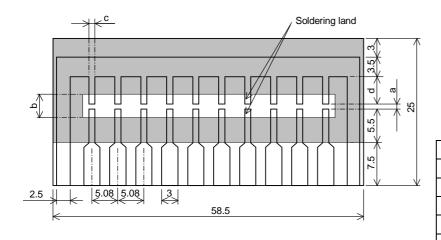
No	Test items	Condition of test (JIS C 5201–1)	Performance requirements	
11	Mounting  Variation of resistance with temperature	Sub-clause 4.31 Substrate material: Epoxide woven glass Test substrate: Figure-3 Sub-clause 4.8 RGC1/32: +20 °C / +125 °C RGC1/20,1/16S,1/16,1/10,1/8: +20 °C / +155 °C	As in Table–1	
12	Mounting  Damp heat, steady state	Sub-clause 4.31 Substrate material: Epoxide woven glass Test substrate: Figure–3 Sub-clause 4.24 Ambient temperature: 40 °C ± 2 °C Relative humidity: 93+3/2 % a) 1st group: without voltage applied. b) 2nd group: The d.c.voltage shall be applied continuously. The voltage shall be accordance with Sub-clause 4.24.2.1 b). without polarizing voltage [4.24.2.1, c)] Visual examination Resistance	No visible damage Legible marking ΔR ≤ ± (5%+0.1Ω)	
13	Dimensions (detail)  Mounting  Endurance at upper category temperature	Sub-clause 4.4.3  Sub-clause 4.31  Substrate material: Epoxide woven glass Test substrate: Figure-3  Sub-clause 4.25.3  RGC1/32:  Ambient temperature:125 °C ± 2 °C  RGC1/20,1/16S,1/16,1/10,1/8:  Ambient temperature:155 °C ± 2 °C  Duration: 1000 h  Examination at 48 h, 500 h and 1000 h:  Visual examination Resistance	As in Table–3  No visible damage $\Delta R \le \pm (5\%+0.1\Omega)$	

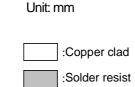
RGC1/32,1/20,1/16S,1/16,1/10,1/8 Page: 9/13

#### 8. Test substrate



**RGC1/8 TEST SUBSTRATE** 





Style	а	b	С	d
RGC1/32	0.2	0.56	0.2	5.3
RGC1/20	0.3	1.5	0.45	5.2
RGC1/16S	0.6	1.9	0.7	4.9
RGC1/16	1.0	3.6	1.0	4.5
RGC1/10	1.2	4.0	1.5	4.3

RGC1/32,1/20,1/16S,1/16,1/10 TEST SUBSTRATE

Figure-3

Remark 1). Material: Epoxide woven glass

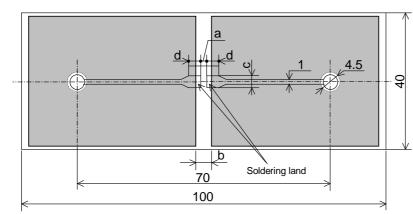
Thickness: 1.6mm Thickness of copper clad: 0.035mm

2). In the case of connection by connector, the connecting terminals are gold plated. However, the plating is not necessary when the connection is made by soldering.

Page:

FIXED THICK FILM CHIP RESISTORS; RECTANGULAR TYPE & PRECISION

RGC1/32,1/20,1/16S,1/16,1/10,1/8



# Unit: mm :Copper clad :Solder resist

Style	а	b	С	d
RGC1/20	0.3	1.1	0.45	2.15
RGC1/16S	0.6	1.9	0.7	2.0
RGC1/16	1.0	3.6	1.2	3.0
RGC1/10	1.2	4.0	1.65	3.0
RGC1/8	2.5	5.0	2.0	2.5

# RGC BOUND STRENGTH OF THE END FACE PLATING TEST SUBSTRATE

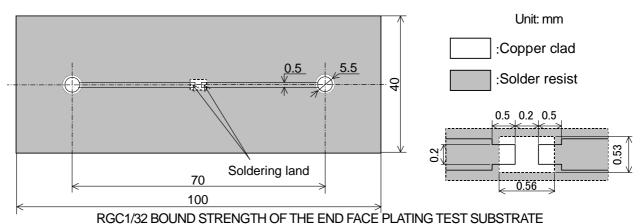
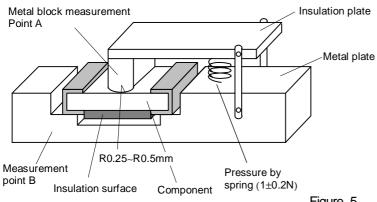


Figure-4

Remark 1). Material: Epoxide woven glass

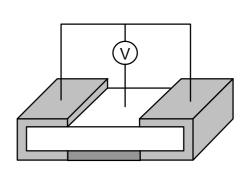
Thickness: 1.6mm Thickness of copper clad: 0.035mm

# • RGC1/16S,1/16,1/10,1/8





# •RGC1/32,1/20



RGC1/32,1/20,1/16S,1/16,1/10,1/8 Page: 11/13

# 9. Taping

- 9.1 Applicable documents JIS C 0806–3: 2014, EIAJ ET–7200C: 2010
- 9.2 Taping dimensions
- 9.2.1 Press pocket taping (Paper taping, 8mm width, 2mm pitches)

Taping dimensions shall be in accordance with Figure-6 and Table-5.

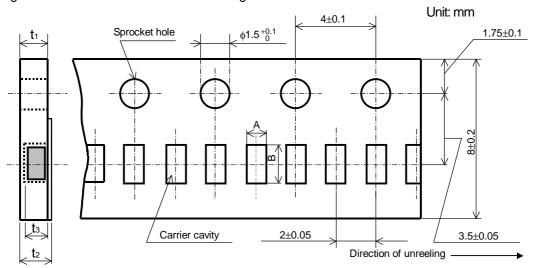
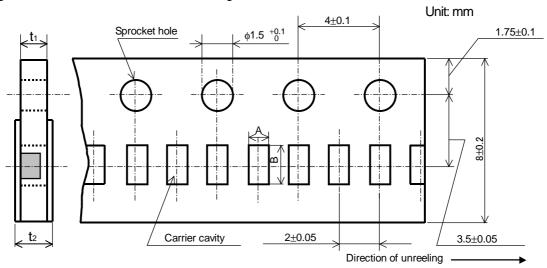


Figure-6 Table-5 Unit: mm В Style RGC1/32 0.24±0.03 0.45±0.03 0.31±0.03 0.36±0.03 0.15±0.02 RGC1/20 0.37±0.05 0.67±0.05 0.42±0.03 0.45±0.05 0.27±0.02

# 9.2.2 Paper taping (8mm width, 2mm pitches)

Taping dimensions shall be in accordance with Figure-7 and Table-6.



No: RGC-K-HTS-0001

Page:

Title: FIXED THICK FILM CHIP RESISTORS; RECTANGULAR TYPE & PRECISION RGC1/32,1/20,1/16S,1/16,1/10,1/8

# 9.2.3 Paper taping (8mm width, 4mm pitches)

Taping dimensions shall be in accordance with Figure-8 and Table-7.

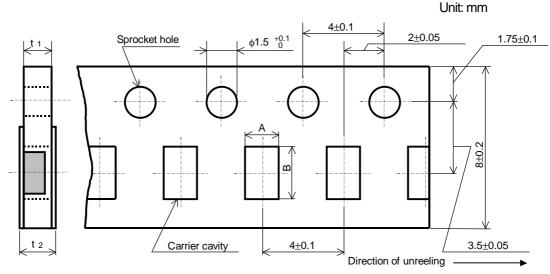
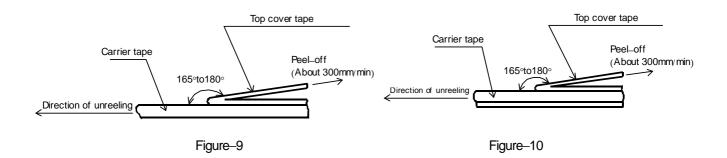


Figure-8

Table_7				Unit: mm
Style	Α	В	<b>t</b> 1	<b>t</b> 2
RGC1/16	$1.15 \pm 0.15$	$1.9 \pm 0.2$	$0.6 \pm 0.1$	0.8max.
RGC1/10	$1.65 \pm 0.15$	$2.5 \pm 0.2$	0.8 ± 0.1	1.0max.
RGC1/8	$2.00 \pm 0.15$	$3.6 \pm 0.2$	0.0 ± 0.1	1.0Hax.

- 1). The cover tapes shall not cover the sprocket holes.
- 2). Tapes in adjacent layers shall not stick together in the packing.
- 3). Components shall not stick to the carrier tape or to the cover tape.
- 4). Pitch tolerance over any 10 pitches ±0.2mm.
- 5). The peel strength of the top cover tape shall be with in 0.1N to 0.5N on the test method as shown in the following RGC1/32,1/20: Figure–9, RGC1/16S, 1/16, 1/10, 1/8: Figure–10.
- 6). When the tape is bent with the minimum radius for 25 mm, the tape shall not be damaged and the components shall maintain their position and orientation in the tape.
- 7). In no case shall there be two or more consecutive components missing.

  The maximum number of missing components shall be one or 0.1%, whichever is greater.
- 8). The resistors shall be faced to upward at the over coating side in the carrier cavity.

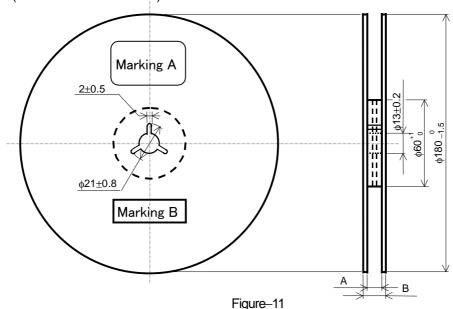


RGC1/32,1/20,1/16S,1/16,1/10,1/8 Page: 13/13

#### 9.3 Reel dimension

Reel dimensions shall be in accordance with the following Figure–11 and Table–8. Plastic reel (Based on EIAJ ET–7200C)

Unit: mm



 Table–8
 Unit: mm

 Style
 A
 B
 Note

 RGC1/32,1/20,1/16S,1/16,1/10,1/8
 9 +1.0 0 11.4±1.0 Injection molding 13±1.0 Vacuum forming

Note: Marking label shall be marked on a place of Marking A or two place of marking A and B.

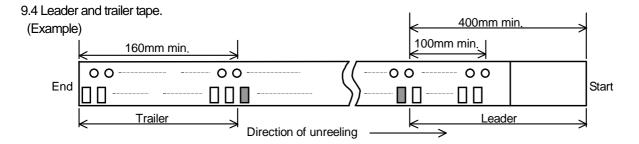


Figure-12

# 10. Marking on package

The label of a minimum package shall be legibly marked with follows.

# 10.1 Marking A

(1) Classification

(Style, Temperature coefficient of resistance, Rated resistance, Tolerance on rated resistance, Packaging form)

(2) Quantity (3) Lot number (4) Manufacturer's name or trade mark (5) Others

10.2 Marking B (KAMAYA control label)

# **X-ON Electronics**

Largest Supplier of Electrical and Electronic Components

Click to view similar products for Thick Film Resistors - SMD category:

Click to view products by Kamaya manufacturer:

Other Similar products are found below:

CR-05FL7--19K6 CR-05FL7--243R CR-05FL7--40K2 CR-12JP4--680R CRCW04021K20FKEE CRCW06036K80FKEE

M55342K06B309DRS3 M55342K06B6E81RS3 M55342K08B100DRWB M55342M05B200DRWB M55342M06B26E7RS3 MC0603-511
JTW 742C083750JTR MCR01MZPF1202 MCR01MZPF1601 MCR01MZPF1800 MCR01MZPF6201 MCR01MZPF9102 MCR01MZPJ113

MCR01MZPJ121 MCR01MZPJ125 MCR01MZPJ203 MCR01MZPJ751 MCR01MZPJ822 MCR03EZHJ103 MCR03EZPFX1272

MCR03EZPJ123 MCR03EZPJ270 MCR03EZPJ821 MCR10EZPF1102 MCR10EZPF2003 MCR10EZPF2700 MCR18EZPJ330

RC0603F1473CS RC0603F150CS RC1005F1152CS RC1005F1182CS RC1005F1372CS RC1005F183CS RC1005F1911CS

RC1005F1912CS RC1005F203CS RC1005F2052CS RC1005F2431CS RC1005F3011CS RC1005F303CS RC1005F4321CS

RC1005F4642CS RC1005F471CS RC1005F4751CS